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FDC6506P

Dual P-Channel Logic Level PowerTrench | MOSFET

General Description

These P-Channel logic level MOSFETs are produced using ON Semiconductor's advanced PowerTrench process that has been especially tailored to minimize on-state resistance and yet maintain low gate charge for superior switching performance.

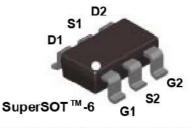
These devices have been designed to offer exceptional power dissipation in a very small footprint for applications where the bigger more expensive SO-8 and TSSOP-8 packages are impractical.

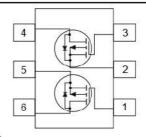
Applications

- Load switch
- · Battery protection
- Power management

Features

- -1.8 A, -30 V. $R_{DS(on)}$ = 0.170 Ω @ V_{GS} = -10 V $R_{DS(on)}$ = 0.280 Ω @ V_{GS} = -4.5 V
- · Low gate charge (2.3nC typical).
- · Fast switching speed.
- High performance trench technology for extremely low $R_{\mbox{\tiny DS(ON)}}.$
- SuperSOTTM-6 package: small footprint (72% smaller than standard SO-8); low profile (1mm thick).





Absolute Maximum Ratings TA = 25°C unless otherwise noted

Symbol	Parameter		Ratings	Units	
V _{DSS}	Drain-Source Voltage		-30	V	
V _{GSS}	Gate-Source Voltage		±20	V	
ID	Drain Current - Continuous - Pulsed	(Note 1a)	-1.8 -10	Α	
P _D	Power Dissipation for Single Operation	(Note 1a)	0.96	W	
		(Note 1b)	0.9		
		(Note 1c)	0.7		
T _J , T _{stg}	Operating and Storage Junction Temperature Range		-55 to +150	°C	

Thermal Characteristics

R _{OJA}	Thermal Resistance, Junction-to-Ambient	(Note 1a)	130	°C/W
Reuc	Thermal Resistance, Junction-to-Case	(Note 1)	60	°C/W

Package Outlines and Ordering Information

Device Marking	Device	Reel Size	Tape Width	Quantity
.506	FDC6506P	7"	8mm	3000 units

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Char	acteristics					
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} = 0 V, I _D = -250 µA	-30			V
<u>A</u> BVoss ΔTJ	Breakdown Voltage Temperature Coefficient	I _D = -250 µ A, Referenced to 25°C		-20		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = -24 V, V _{GS} = 0 V			-1	μА
I _{GSSF}	Gate-Body Leakage Current, Forward	V _{GS} = 20 V, V _{DS} = 0 V			100	nA
I _{GSSR}	Gate-Body Leakage Current, Reverse	V _{GS} = -20 V, V _{DS} = 0 V			-100	nA
On Char	acteristics (Note 2)					
V _{GS(th)}	Gate Threshold Voltage	V _{DS} = V _{GS} , I _D = -250 µA	-1	-1.8	-3	V
ΔVas(#h) ΔTJ	Gate Threshold Voltage Temperature Coefficient	I _D = -250 µ A, Referenced to 25°C		4		mV/∘C
R _{DS(on)}	Static Drain-Source On-Resistance	V _{GS} = -10 V, I _D = -1.8 A V _{GS} = -10 V, I _D = -1.8 A @125°C V _{GS} = -4.5 V, I _D = -1.4 A		0.14 0.20 0.22	0.17 0.27 0.28	Ω
I _{D(on)}	On-State Drain Current	V _{GS} = -10 V, V _{DS} = -5 V	-10			Α
g _{FS}	Forward Transconductance	$V_{DS} = -5 \text{ V}, I_{D} = -1.8 \text{ A}$		3		S
Dynamic	Characteristics					
Ciss	Input Capacitance	V _{DS} = -15 V, V _{GS} = 0 V,		190		pF
Coss	Output Capacitance	f = 1.0 MHz		70		pF
Cres	Reverse Transfer Capacitance			30		pF
Switchin	g Characteristics (Note 2)					
t _{d(an)}	Turn-On Delay Time	$V_{DD} = -15 \text{ V}, I_D = -1 \text{ A},$		7	14	ns
tr	Turn-On Rise Time	$V_{GS} = -4.5 \text{ V}, R_{GEN} = 6 \Omega$		8	16	ns
t _{d(off)}	Tum-Off Delay Time			14	25	ns
t _f	Turn-Off Fall Time			2	6	ns
Qg	Total Gate Charge	V _{DS} = -5 V, I _D = -1.8 A, V _{GS} = -10 V		2.3	3.5	nC
Qgs	Gate-Source Charge			1		nC
Q _{gd}	Gate-Drain Charge	<u> </u>		0.8		nC
Drain-So	urce Diode Characteristics and	d Maximum Ratings				
ls	Maximum Continuous Drain-Source Diode Forward Current				-0.8	Α
V _{SD}	Drain-Source Diode Forward Voltage	V _{GS} = 0 V, I _S = -0.8 A (Note 2)		-0.8	-1.2	V

Notes:

^{1.} R_{QUA} is the sum of the junction-to-case and case-to-ambient resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R_{BLC} is guaranteed by design while R_{BLA} is determined by the user's board design.Both devices are assumed to be operating and sharing the dissipated heat energy equally.



a) 130 °C/W when mounted on a 0.125 in² pad of 2 oz. copper.



b) 140 °C/W when mounted on a 0.005 in² pad of 2 oz. copper.



c) 180 °C/W when mounted on a 0.0015 in² pad of 2 oz. copper.

Scale 1 : 1 on letter size paper

2. Pulse Test: Pulse Width ≤ 300 µs, Duty Cycle ≤ 2.0%

Typical Characteristics

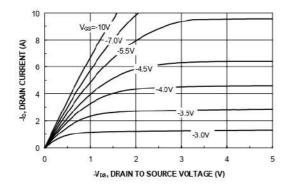


Figure 1. On-Region Characteristics.

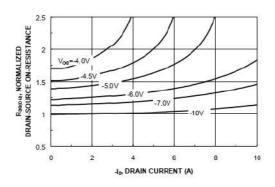


Figure 2. On-Resistance Variation with Drain Current and Gate Voltage.

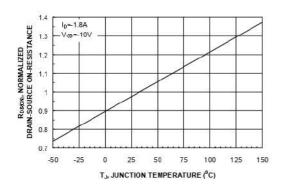


Figure 3. On-Resistance Variation with Temperature.

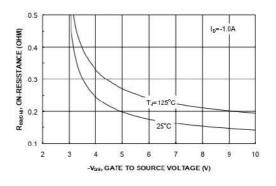


Figure 4. On-Resistance Variation with Gate-to-Source Voltage.

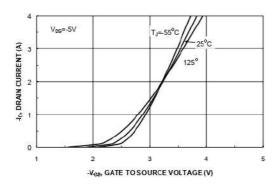


Figure 5. Transfer Characteristics.

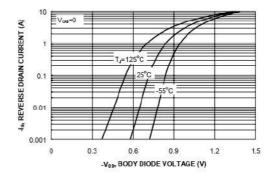
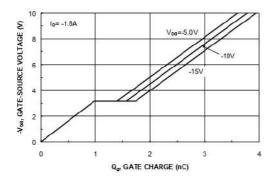


Figure 6. Body Diode Forward Voltage Variation with Source Current and Temperature.

Typical Characteristics (continued)



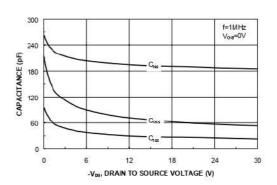
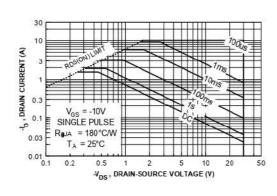


Figure 7. Gate-Charge Characteristics.

Figure 8. Capacitance Characteristics.



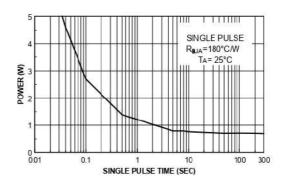


Figure 9. Maximum Safe Operating Area.

Figure 10. Single Pulse Maximum Power Dissipation.

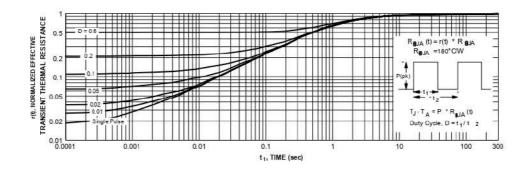


Figure 11. Transient Thermal Response Curve.

Thermal characterization performed using the conditions described in Note 1c. Transient themal response will change depending on the circuit board design.

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